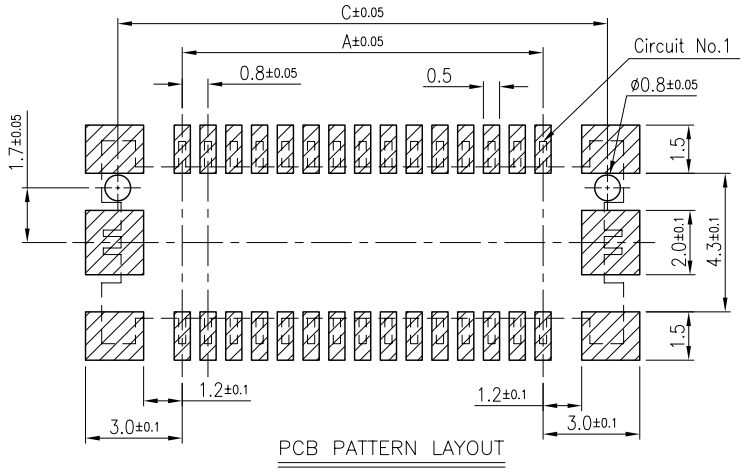


NOTES:
1. MATERIAL:
   1.1 HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP.,UL94V-0.
   1.2 CONTACT: COPPER ALLOY
   1.3 FITTING NAIL: COPPER ALLOY
2. REFLOW SOLDER CAPABLE TO 260° C PER ACES SPEC.
3. WAVE SOLDER CAPABLE TO 260° C PER ACES SPEC.
4. PACKAGE PLS. REFER TO 88022-XXX0-TRP
5. SPEC PLS. REFER TO SPEC-50121-XXXXX-XXX.

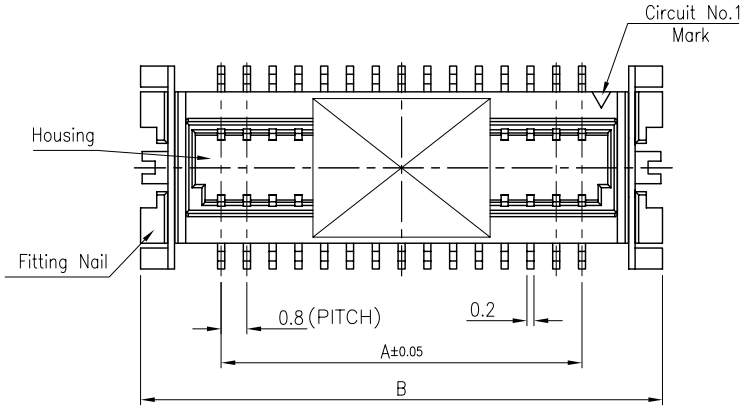
P/N LEGEND
50121-XXX X X-XXX

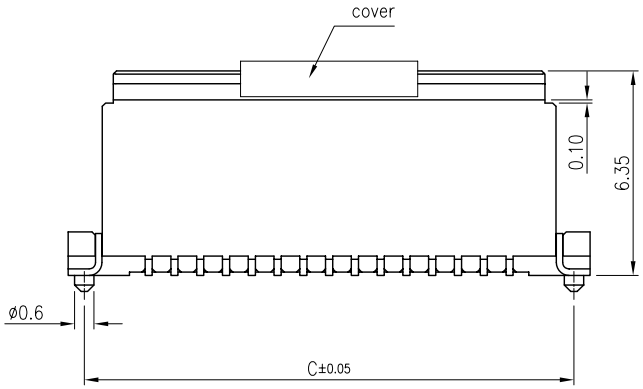
CKTS

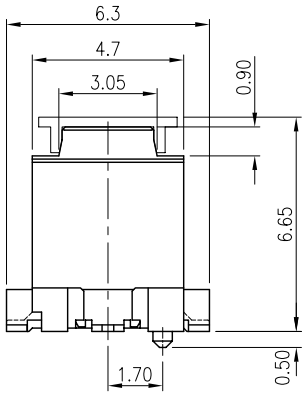
PACKING
0:TAPE&REEL
1:TUBE
7:REEL WIHT COVER
8:TUBE WITH COVER

PLATING
1:GOLD FLASH OVER ALL
N:MATT TIN(LEAD FREE)

XXX	MATERIAL	COLOR
001	HF PLASTIC	BLACK







CKT	DIM A	DIM B	DIM C
12	4.0	9.0	8.0
14	4.8	9.8	8.8
16	5.6	10.6	9.6
24	8.8	13.8	12.8
26	9.6	14.6	13.6
30	11.2	16.2	15.2
40	15.2	20.2	19.2
50	19.2	24.2	23.2

修訂 REV	修改摘要 REVISION DESCRIPTION	日期 DATE	簽名 SIGNATURE
O	新圖製成	08/10/07	Keen

一般公差 TOLERANCES
X. ±0.5 .XX ±0.15
.X ±0.25 .XXX ±0.1
ANGLES ±2°

宏致電子股份有限公司
Aces Electronic Co.,Ltd.

檢驗尺寸標示
SYMBOLS ◎ Ⓜ INDICATE CLASSIFICATION DIMENSION
◎ MARK IS CRITICAL DIM.
Ⓜ MARK IS MAJOR DIM.

品名 (TITLE): 0.8mm BTB D/R CONN. SMT S/T TYPE

圖號 (DWG.NO): 50121-XXXXX-XXX

表面處理 (FINISH)

製圖 (DR): Keen 08/10/07
審核 (CHKD): WGCH
核准 (APPD): Jason.C

比例 (SCALE): 5:1
單位 (UNITS): mm
張數 (SHEET): 1 OF 1
SIZE: A4
REV: O